



Free Space Isolator Epoxy (FSIE Series)

Description

The Free Space Isolator Epoxy is designed for integration within laser diode package to prevent back reflection. The high isolation, low insertion loss and large aperture features make the optical isolator epoxy flexible to fit with different diode laser packaging requirements.

Key Features

- High Isolation
- Low Insertion Loss

Applications

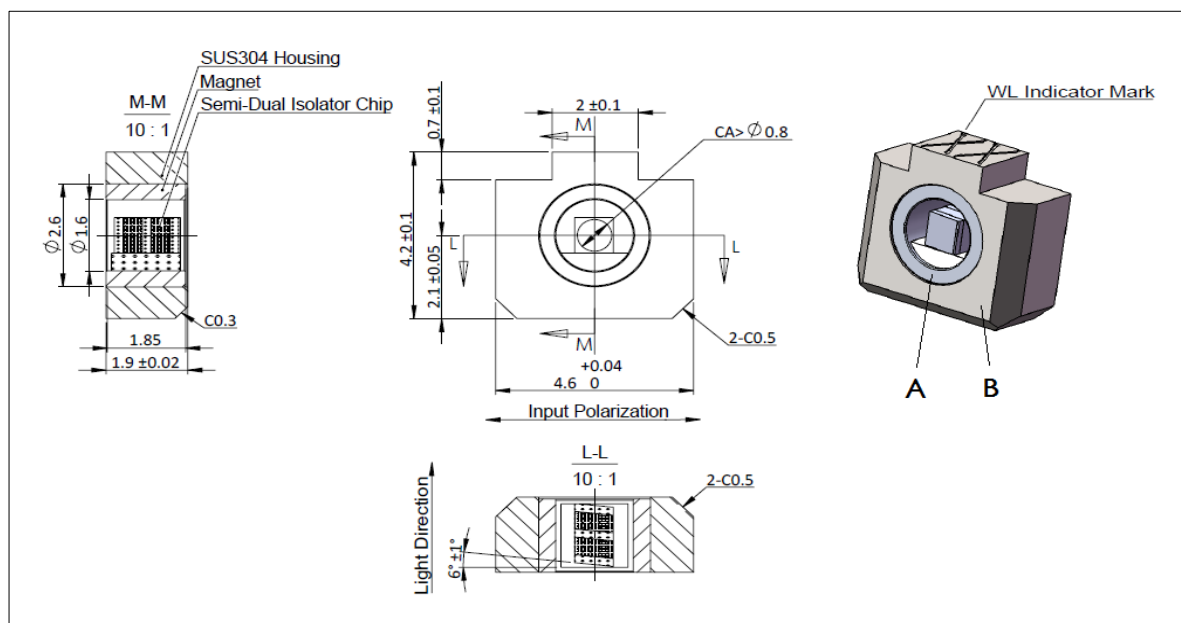
- Laser Chip

Specifications

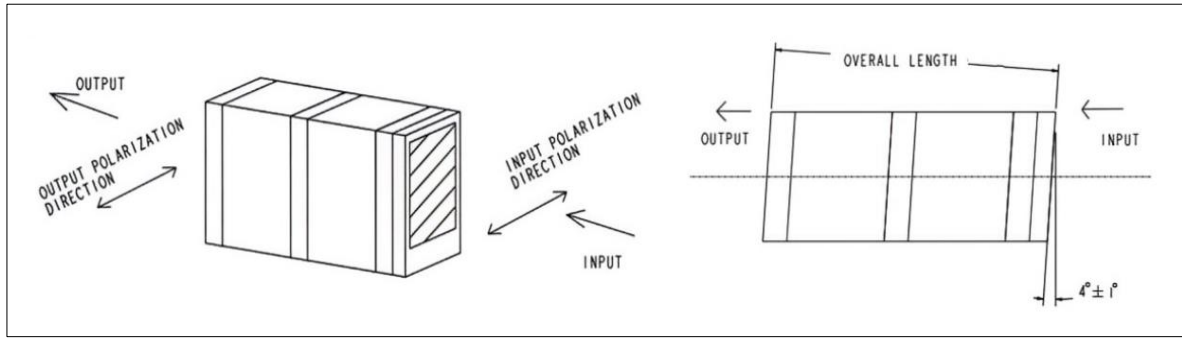
Parameter	Unit	Value	
Stage	-	Single Stage	Dual Stage
Center Wavelength (λ_c)	nm	1310 or 1550	
Typ. Insertion Loss	dB	0.12	0.20
Max. Insertion Loss	dB	0.30	0.50
Peak Isolation	dB	40	55
Min. Isolation, 23 °C	dB	30	40
Clear Aperture	mm	0.4 - 0.9	
Max. Optical Power (Continuous Wave)	mW	300	
Polarization Plane of Input	-	Indicated in Package Diagram	
Tilt Angle of Input Plane	degree	4, 6	
Operating Temperature	°C	0 to + 60	
Storage Temperature	°C	- 40 to + 85	

Package Dimensions

Non-Latching Type



Latching Type



Ordering Information

FSIE-①-②②-③③-④-⑤

①: Stage

1 - Single Stage

2 - Semi-Double Stage

②②: Wavelength

31 - 1310 nm

48 - 1480 nm

55 - 1550 nm

SS - Specify

③③: Clear Aperture

07 - Ø 0.7 mm

08 - Ø 0.8 mm

09 - Ø 0.9 mm

SS - Specify

④: Package

1 - Ø 2.6 × Ø 1.6 × 1.85 mm Magnet, No Housing (Refer to A)

2 - Ø 2.2 × Ø 1.6 × 1.7 mm Magnet, No Housing

3 - 4.6 × 1.9 × 4.2 - Ø 2.6 mm Housing (Refer to B)

4 - 3.5 × 1.7 × 3.85 - Ø 2.2 mm Housing

N - Latching Type With out Magnet Tube

S - Specified

⑤: Type

1 - Non-Latching Type

2 - Latching Type

⑥: Angle

4 - 4°

6 - 6°